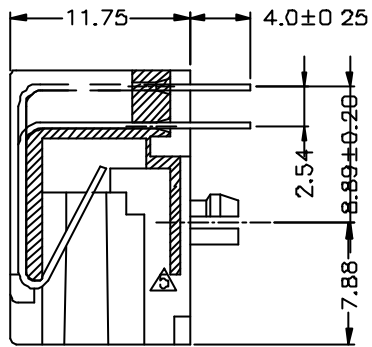
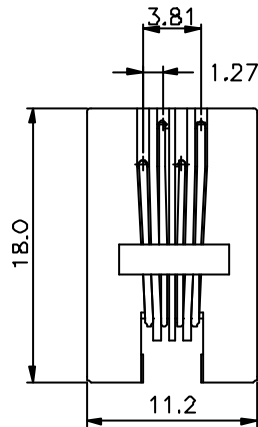
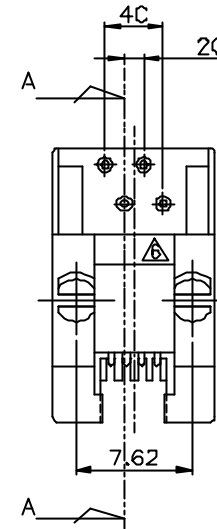




SECTION A-A



REVISION RECORD				
REV	ECO	DESCRIPTION	DRFT	CHKD
1		MODIFY PART NO.	8/23/98	
2		MODIFY DIMENSION	8/24/02	
3		MODIFY DIMENSION	11/15/04	
4		ADD PART NUMBER	08/01/04	
5		MODIFY DRAWING	07/01/00	
6		MODIFY DRAWING	07/16/00	
7		MODIFY NOTES	10/24/00	

NOTES:ELECTRICAL:

1. VOLTAGE RATING: 125 VAC RMS.
2. CURRENT RATING: 1.5 AMP.
3. CONTACT RESISTANCE: 30 MILLIOHMS MAX.
4. INSULATION RESISTANCE: 1000 MEGOHMS MIN @ 500 VDC.
5. DIELECTRIC STRENGTH: 1000 VAC RMS 60Hz, 1MIN.

MECHANICAL:

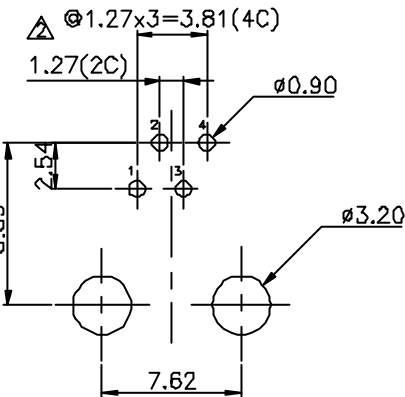
1. HOUSING MATERIAL: GLASS FILLED POLYESTER UL94V-0.
STAND COLOR BLACK.
2. CONTACT MATERIAL: PHOSPHOR BRONZE. $\phi 0.46\text{mm}$.
3. PLATING: GOLD PLATING OVER NICKEL.
4. OPERATING LIFE: 750 CYCLES MIN.
5. PCB RETENTION PRE-SOLDER: 1 LB MIN.
6. PCB RETENTION POST-SOLDER: 10 LBS MIN.

ENVIRONMENTAL:

1. STORAGE: -40°C TO $+85^{\circ}\text{C}$.
 2. OPERATION: 0°C TO 70°C .
- MATES WITH MODULAR PLUG CONFORMING TO
FCC PART 68, SUBPART F.
UL & CUL FILE NO. E163191

PART NUMBER: E534X-000X1X

- Δ 2- 2C
 4- 4C
- 1- 3u" 2- 6u"
 3- 15u" 4- 30u"
 5- 50u" F-GOLD FLASH Δ
- 0-A06-0100 BK
 1-A06-0110 GY Δ
 4-A05-0040 BK Δ
 J-A06-1530 TW



Thickness=1.60mm

PC Board Layout Component Side Shown

DETACHED LISTS	 MM (INCH)		OFFT SYANG	DATE 9/10/97	FULL RISE ELECTRONIC CO., LTD				
	TOLERANCES EXCEPT AS NOTED		CHKD	DATE					
			NFO	DATE					
			APPVL <i>oscar</i>	DATE 10/25/06					
	MM 0.1 ± 0.2 0.05 ± 0.15 0.004 ± 0.075		± ± ±		TITLE 90° VERY L/P PCB JACK 4P				
	ANGLES ± 0.5		MATERIAL :						
			QTY		DRAWING NO. GE533001 /PART NO. SEE NOTE				
	THIRD ANGLE PROJECTION		FINISH .					SIZE A3	REV 7
	SCALE 3:1		DO NOT SCALE DRAWING					SHEET OF	